



MMBD4448W

SURFACE MOUNT FAST SWITCHING DIODE

Features

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 1, 2 and 3)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)

SOT-323



Top View



Top View Internal Schematic

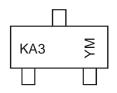
Ordering Information (Notes 3 & 4)

Part Number	Case	Packaging
MMBD4448W-7-F	SOT-323	3000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. Product manufactured with Green Molding Compound and does not contain Halogens or Sb₂O₃ Fire Retardants.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



KA3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Key

Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	N	Р	R	S	Т	U	V	W	Х	Υ	Z	Α	В	С
		1												
Month	Jan	Feb	Mai		Apr	May	Jun	Jul	Aug	Se	p C	Oct	Nov	Dec



Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		Vrrm Vrwm Vr	75	V
RMS Reverse Voltage		V _{R(RMS)}	53	V
Forward Continuous Current (Note 4)		I _{FM}	500	mA
Average Rectified Output Current (Note 4)		I _O	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	4.0 1.0	А

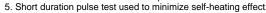
Thermal Characteristics

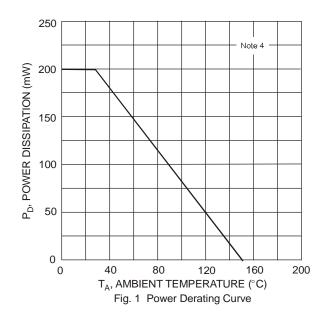
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P_{D}	200	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-65 to +150	°C

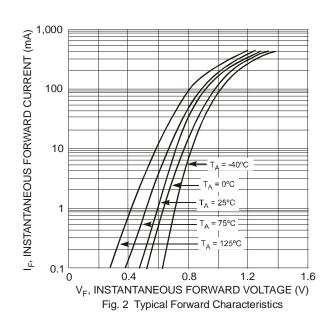
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	75	_	V	$I_R = 10\mu A$		
	V _F 0.855 V I _F = 10mA	0.62	0.72		$I_F = 5.0 \text{mA}$		
Forward Voltage		$I_F = 10mA$					
Tolward voltage		$I_F = 100 \text{mA}$					
		_	1.25		$I_F = 150 \text{mA}$		
	I _R		1.0	μΑ	$V_R = 75V$		
Reverse Current (Note 5)		I _R	l_		50	μΑ	$V_R = 75V, T_J = 150$ °C
Reverse Current (Note 3)			R -	30	μΑ	$V_R = 25V, T_J = 150$ °C	
			25	nA	$V_R = 20V$		
Total Capacitance	C _T	_	2.0	pF	$V_R = 0, f = 1.0MHz$		
Reverse Recovery Time			4.0	20	$I_F = I_R = 10 \text{mA},$		
Neverse Necovery Time	t _{rr}		4.0	ns	$I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100\Omega$		

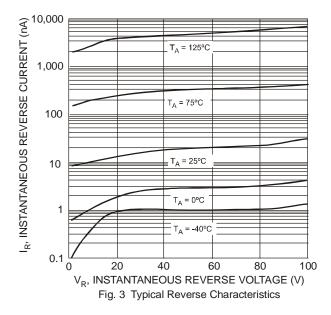
Notes: 4. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com.
5. Short duration pulse test used to minimize self-heating effect.

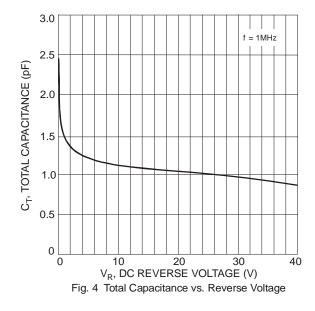




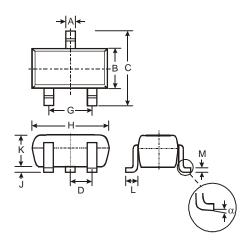






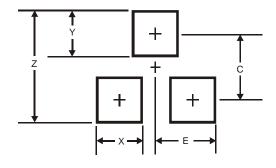


Package Outline Dimensions



	SOT-323						
Dim	Min	Max	Тур				
Α	0.25	0.40	0.30				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	-	-	0.65				
G	1.20	1.40	1.30				
Н	1.80	2.20	2.15				
J	0.0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
M	0.10	0.18	0.11				
α	0°	8°	-				
All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Υ	0.9
С	1.9
E	1.0



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